

HCB65S12D1Q

eSiC Silicon Carbide Schottky Diode

650V, 12A

Description

The 650V eSiC is an advanced Power Master Semiconductor's silicon carbide diode family.

This technology combines the benefits of excellent low capacitive and robustness.

Consequently, the eSiC family is suitable for application requiring high power efficiency.

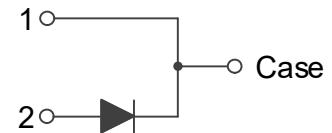
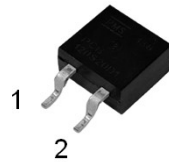
Applications

- Power Factor Correction
- Industrial Power Supplies
- Solar Inverter, UPS

Features

V_{RRM}	I_F	$T_{J,max}$	Q_C
650 V	12 A	175 °C	39 nC

- No reverse recovery current
- Low capacitive charge
- 175°C Max junction temperature
- High surge current capability
- Switching behavior independent of temperature
- Pb-Free, Halogen Free and RoHS compliant



Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive Peak Reverse Voltage	650	V	
I_F	Forward Current	$T_C=138^\circ\text{C}$ 12	A	
$I_{F,SM}$	Non-Repetitive Forward Surge Current	$T_C=25^\circ\text{C}, t_p=10\text{ ms}$	62	A
		$T_C=150^\circ\text{C}, t_p=10\text{ ms}$	52.7	A
$I_{F,Max}$	Non-Repetitive Peak Forward Current	$T_C=25^\circ\text{C}, t_p=10\text{ us}$	665	A
		$T_C=150^\circ\text{C}, t_p=10\text{ us}$	565	A
I^2dt value	$\int i^2 dt$	$T_C=25^\circ\text{C}, t_p=10\text{ ms}$	19.2	A^2s
		$T_C=150^\circ\text{C}, t_p=10\text{ ms}$	13.8	A^2s
P_{tot}	Power Dissipation	$T_C=25^\circ\text{C}$ 94	W	
T_J, T_{STG}	Operating Junction and Storage Temperature	-55 to +175	$^\circ\text{C}$	

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.6	$^\circ\text{C/W}$

Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
HCB65S12D1Q	HCB65S12D1Q	TO-263-2L	Tape & Reel	2500 units

Electrical Characteristics (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V _F	Forward Voltage	I _F =12 A, T _C =25°C		1.40	1.7	V
		I _F =12 A, T _C =175°C		1.55	-	
I _R	Reverse Current	V _R =650 V, T _C =25°C		-	100	μA
		V _R =650 V, T _C =175°C		-	300	
Q _C	Total Capacitive Charge	V _R =400 V, T _C =25°C		39		nC
C	Total Capacitance	V _R =1 V, f=100 kHz		623		pF
		V _R =400 V, f=100 kHz		60		
E _C	Capacitance Stored Energy	V _R =400 V, T _C =25°C		5.7		μJ

Typical Performance Characteristics

Figure 1. Power Derating

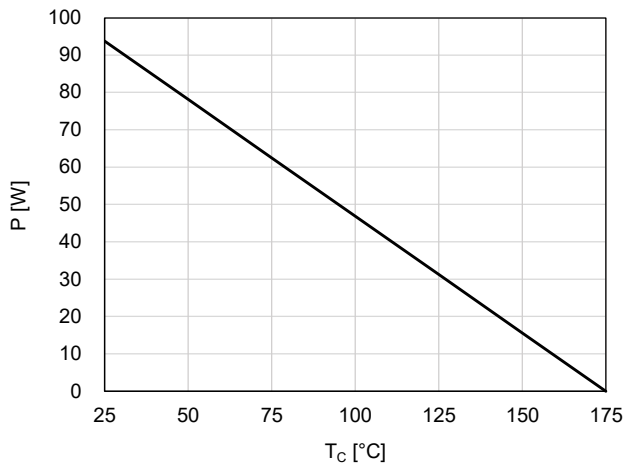


Figure 2. Current Derating

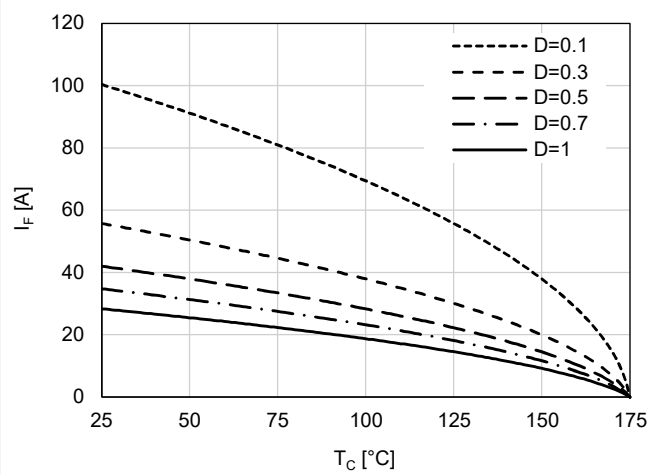


Figure 3. Forward Characteristics

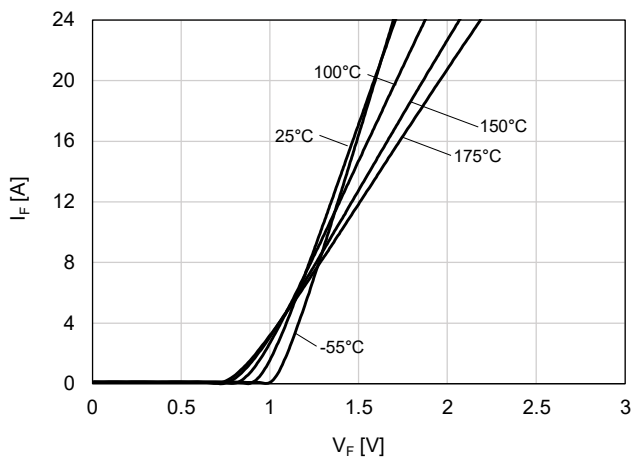


Figure 4. Reverse Characteristics

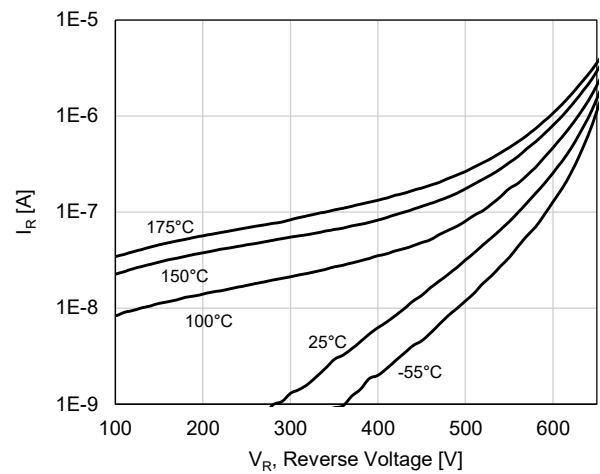


Figure 5. Capacitive Charge Characteristic

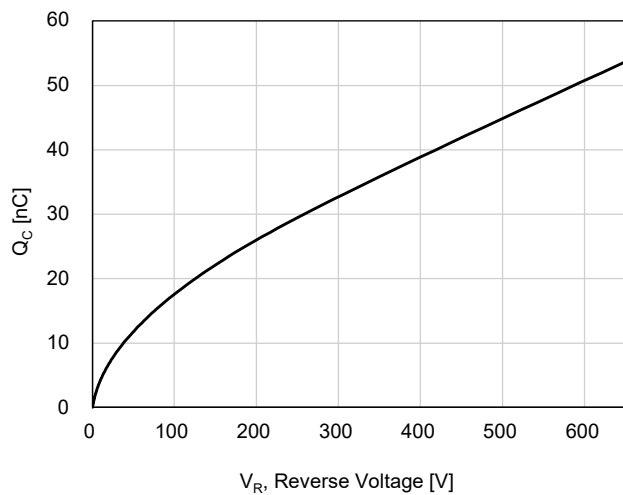
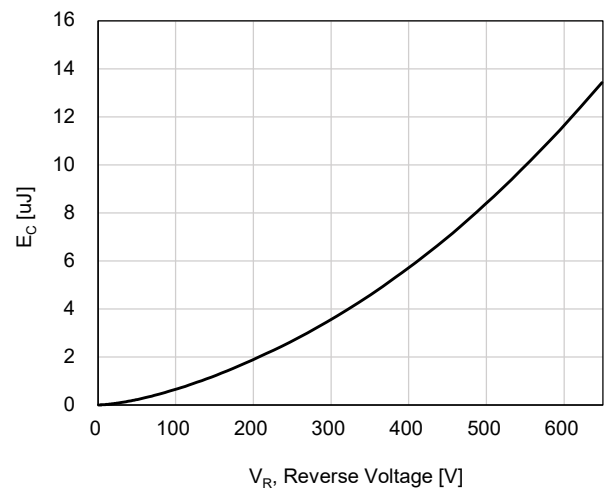


Figure 6. Capacitance Stored Energy



Typical Performance Characteristics

Figure 7. Capacitance Characteristic

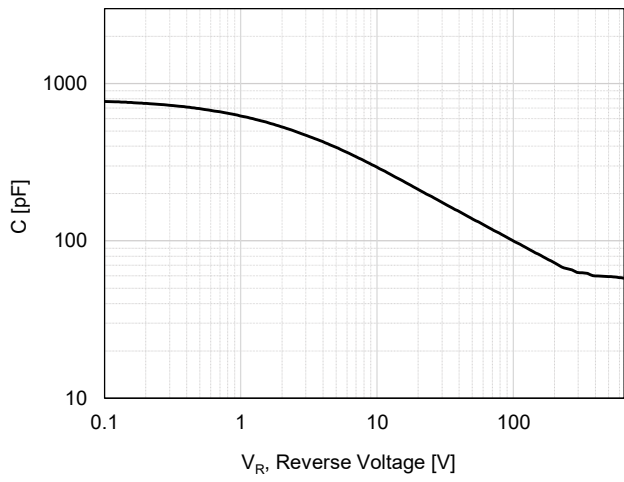
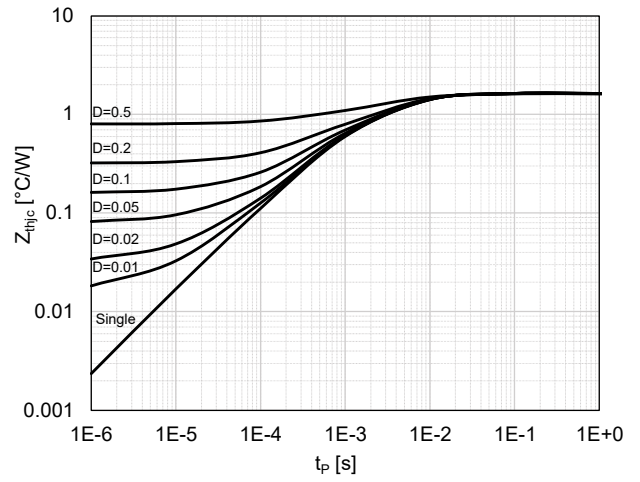
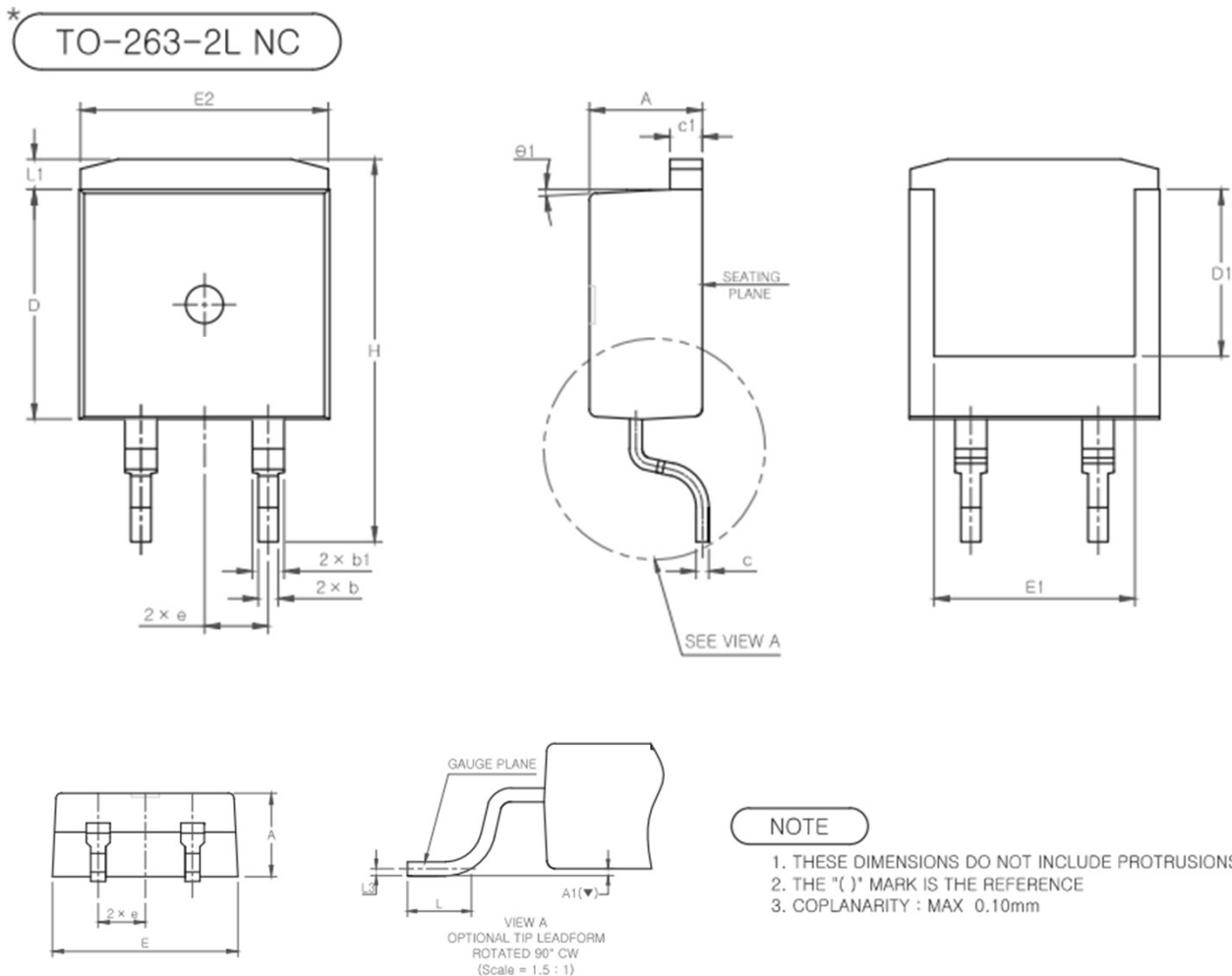


Figure 8. Transient Thermal Response Curve



Package Outlines

TO-263-2L



SYMBOL	MIN	NOM	MAX
A	4.30	4.50	4.70
A1(▽)	0.00	-	0.25
b	0.70	0.80	0.90
b1	1.17	1.27	1.37
c	0.45	0.50	0.60
c1	1.25	1.30	1.40
D	9.00	9.20	9.40
D1	6.50	6.70	6.90
E	9.80	10.00	10.20
E1	7.80	8.00	8.20
E2	9.70	9.90	10.10
e	2.54 BSC		
H	15.00	15.30	15.60
L	2.00	2.30	2.60
L1	1.00	1.20	1.40
L3	0.254 BSC		
θ1	(3°)		

* Dimensions in millimeters